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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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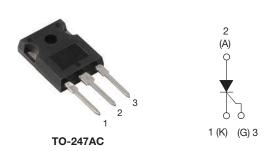




VS-40TPS16PbF, VS-40TPS16-M3

Vishay Semiconductors

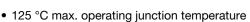
Thyristor High Voltage, Phase Control SCR, 40 A



PRODUCT SUMMARY							
Package	TO-247AC						
Diode variation	Single SCR						
I _{T(AV)}	35 A						
V_{DRM}/V_{RRM}	1600 V						
V_{TM}	1.45 V						
I _{GT}	150 mA						
TJ	-40 °C to 125 °C						

FEATURES

- High voltage (up to 1600 V)
- Designed and qualified according to JEDEC®-JESD47



Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912







APPLICATIONS

 Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding and battery charge

DESCRIPTION

The VS-40TPS16... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	VALUES	UNITS						
I _{T(AV)}	Sinusoidal waveform	35	^						
I _{RMS}		55	A						
V _{RRM} /V _{DRM}		1600	V						
I _{TSM}		500	А						
V _T	40 A, T _J = 25 °C	1.45	V						
dV/dt		1000	V/µs						
dl/dt		100	A/μs						
T _J		-40 to 125	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} /V _{DRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA						
VS-40TPS16PbF, VS-40TPS16-M3	1600	1700	10						



VS-40TPS16PbF, VS-40TPS16-M3

Vishay Semiconductors

ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum average on-state current	I _{T(AV)}	$T_C = 79$ °C, 180 ° conduction half sine wave	35					
Maximum continuous RMS on-state current as AC switch	I _{T(RMS)}			55	Α			
Maximum peak, one-cycle	I _{TSM}	10 ms sine pulse, rated V_{RRM} applied		420				
non-repetitive surge current	TISM	10 ms sine pulse, no voltage reapplied		500				
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated $V_{\mbox{\scriptsize RRM}}$ applied	Initial $T_J = T_{II}$ maximum	880	A ² s			
Wiaximum i-t for fusing	I-t	10 ms sine pulse, no voltage reapplied	. 0	1250	A-S			
Maximum I ² √t for fusing	I ² √t	t = 0.1 to 10 ms, no voltage reapplied	12 500	A²√s				
Low level value of threshold voltage	V _{T(TO)1}			1.02	V			
High level value of threshold voltage	V _{T(TO)2}	T 105 °C	1.23	v				
Low level value of on-state slope resistance	r _{t1}	T _J = 125 °C	9.74	0				
High level value of on-state slope resistance	r _{t2}			7.50	mΩ			
Maximum peak on-state voltage	V_{TM}	110 A, T _J = 25 °C		1.85	V			
Maximum rate of rise of turned-on current	dl/dt	T _J = 25 °C		100	A/μs			
Maximum holding current	I _H	Anode supply = 6 V, resistive load, initial I_T	200					
Maximum latching current	ΙL	Anode supply = 6 V, resistive load, T _J = 25	300	1 .				
Marian na n		T _J = 25 °C		0.5	mA			
Maximum reverse and direct leakage current	I _{RRM} /I _{DRM}	$T_J = 125 ^{\circ}\text{C}$ $V_R = \text{Rated } V_{RRM} / V_{DR}$	V _R = Rated V _{RRM} /V _{DRM}					
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum, linear to 80 % V_{DRM} , $R_g - k = Open$ 1000						

TRIGGERING					
PARAMETER	SYMBOL	7	TEST CONDITIONS		
Maximum peak gate power	P_{GM}				
Maximum average gate power	P _{G(AV)}			2.5	W
Maximum peak gate current	I _{GM}			2.5	Α
Maximum peak negative gate voltage	- V _{GM}			10	
Maximum required DC gate voltage to trigger		T _J = - 40 °C	Anode supply = 6 V resistive load	4.0	V mA
	V_{GT}	T _J = 25 °C		2.5	
voltage to trigger		T _J = 125 °C		1.7	
		T _J = - 40 °C		270	
Maximum required DC gate augreent to trigger	l _{GT}	T _J = 25 °C	Anode supply = 6 V resistive load	150	
Maximum required DC gate current to trigger		T _J = 125 °C		80	
		T _J = 25 °C, for 40TPS08A		40	
Maximum DC gate voltage not to trigger	V_{GD}	T _J = 125 °C, V _{DRM} = Rated value		0.25	V
Maximum DC gate current not to trigger	I_{GD}	$\int_{0}^{\infty} J = 125 \text{ C}, \text{ VDR}$	6	mA	



THERMAL AND MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temperature range		T_J , T_{Stg}		-40 to 125	°C				
Maximum thermal resistance, junction to case		R_{thJC}	DC operation	0.6					
Maximum thermal resistance, junction to ambient		R _{thJA}		40	°C/W				
Maximum thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.2					
Approximate weight				6	g				
Approximate weight				0.21	OZ.				
Mounting torque	minimum			6 (5)	kgf · cm				
wounting torque	maximum			12 (10)	(lbf · in)				
Marking device			Case style TO-247AC	40TPS16					

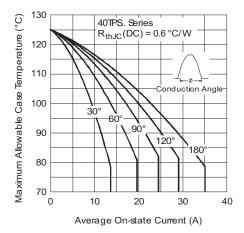


Fig. 1 - Current Rating Characteristics

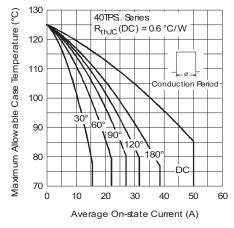


Fig. 2 - Current Rating Characteristics

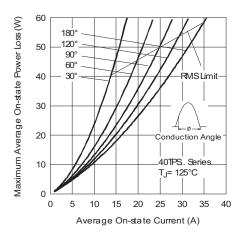


Fig. 3 - On-State Power Loss Characteristics

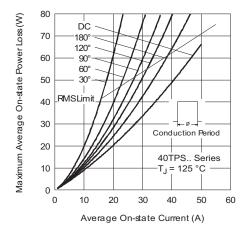


Fig. 4 - On-State Power Loss Characteristics

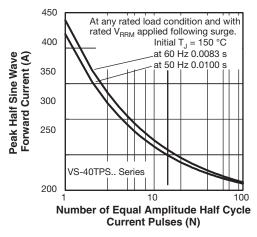


Fig. 5 - Maximum Non-Repetitive Surge Current

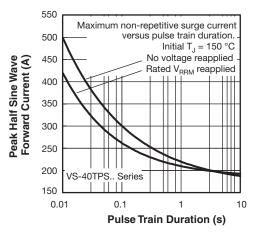


Fig. 6 - Maximum Non-Repetitive Surge Current

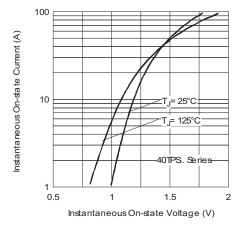


Fig. 7 - On-State Voltage Drop Characteristics

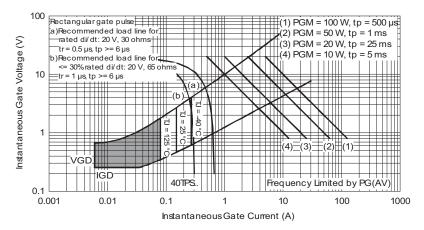


Fig. 8 - Gate Characteristics

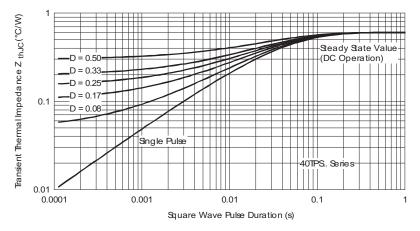
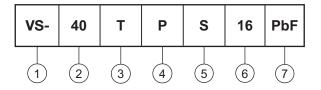


Fig. 9 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- 2 Current rating (40 = 40 A)
- Circuit configuration:

T = Thyristor

4 - Package:

P = TO-247

5 - Type of silicon:

S = Standard recovery rectifier

6 - Voltage rating (16 = 1600 V)

7 - Environmental digit:

PbF = Lead (Pb)-free and RoHS compliant

-M3 = Halogen-free, RoHS compliant, and terminations lead (Pb)-free

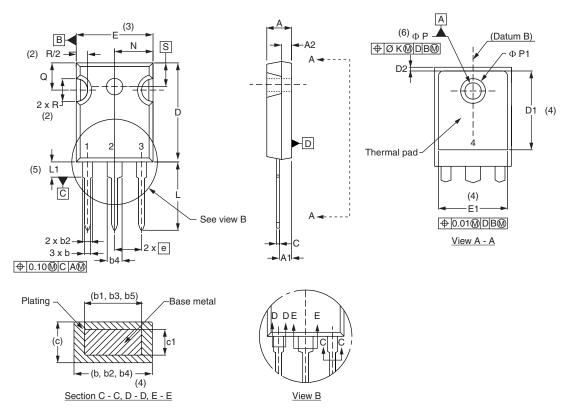
ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-40TPS16PbF	25	500	Antistatic plastic tubes					
VS-40TPS16-M3	25	500	Antistatic plastic tubes					

LINKS TO RELATED DOCUMENTS						
Dimensions <u>www.vishay.com/doc?95542</u>						
Dout moulcing information	TO-247AC PbF	www.vishay.com/doc?95226				
Part marking information	TO-247AC -M3	www.vishay.com/doc?95007				



TO-247 - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	MILLIMETERS IN		INCHES		NOTES	SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	'	STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	BSC	
b1	0.99	1.35	0.039	0.053			ØK	0.2	254	0.0	10	
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			N	7.62	BSC	0	.3	
b5	2.59	3.38	0.102	0.133			ØΡ	3.56	3.66	0.14	0.144	
С	0.38	0.89	0.015	0.035			Ø P1	-	7.39	-	0.291	
c1	0.38	0.84	0.015	0.033			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3		R	4.52	5.49	0.178	0.216	
D1	13.08	-	0.515	-	4		S	5.51	BSC	0.217	BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- $^{(7)}$ Outline conforms to JEDEC $^{\circledR}$ outline TO-247 with exception of dimension c and Q



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Vishay

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